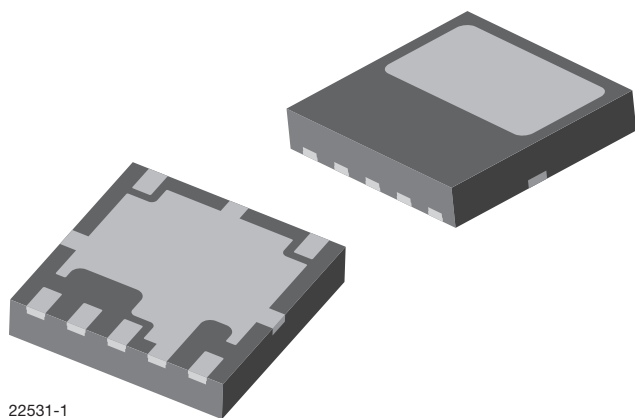




IR Receiver Modules for Remote Control Systems



22531-1

DESIGN SUPPORT TOOLS


[click logo to get started](#)

ORDERING CODE

Taping:

TSOP37...TT1 - top view taped

TSOP37...TT2 - top view taped

FEATURES

- Very low supply current
- Photo detectors and preamplifier in one package
- Internal filter for PCM frequency
- Supply voltage: 2.5 V to 5.5 V
- Improved immunity against ambient light
- Insensitive to supply voltage ripple and noise
- Material categorization:

for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

DESCRIPTION

The TSOP373.., TSOP375.. series are miniaturized receiver modules for infrared remote control systems. A PIN diode and a preamplifier are assembled on a PCB, the epoxy package contains an IR filter. The demodulated output signal can be directly connected to a microprocessor for decoding.

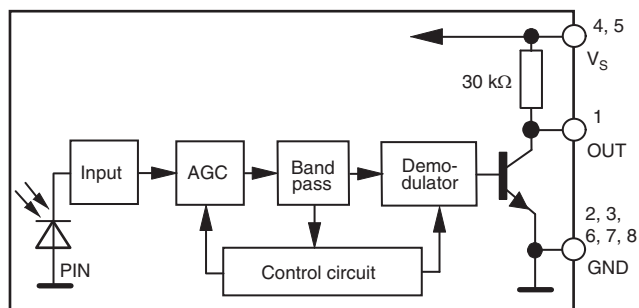
The TSOP373.. series devices are optimized to suppress almost all spurious pulses from energy saving lamps like CFLs. AGC3 may also suppress some data signals if continuously transmitted.

New designs should prefer the TSOP373.. series containing the newer AGC3. The TSOP375.. series contain a very robust AGC5. This series should only be used for critically noisy environments.

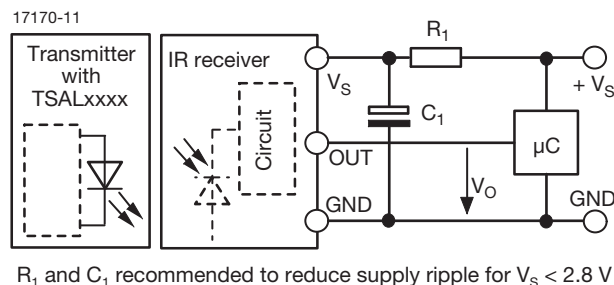
These components have not been qualified according to automotive specifications.

PARTS TABLE

| AGC | | NOISY ENVIRONMENTS AND SHORT BURSTS (AGC3) | VERY NOISY ENVIRONMENTS AND SHORT BURSTS (AGC5) |
|-------------------|--------|--|--|
| Carrier frequency | 36 kHz | TSOP37336 ⁽¹⁾ | TSOP37536 |
| | 38 kHz | TSOP37338 ⁽²⁾⁽³⁾⁽⁴⁾⁽⁵⁾ | TSOP37538 |
| | 40 kHz | TSOP37340 | TSOP37540 |
| | 56 kHz | TSOP37356 | TSOP37556 |
| Package | | Belobog | |
| Pinning | | 1 = OUT, 2, 3, 6, 7, 8 = GND, 4, 5 = V _S | |
| Dimensions (mm) | | 3.95 W x 3.95 H x 0.8 D | |
| Mounting | | SMD | |
| Application | | Remote control | |
| Best choice for | | ⁽¹⁾ MCIR ⁽²⁾ Mitsubishi ⁽³⁾ RECS-80 Code ⁽⁴⁾ r-map ⁽⁵⁾ XMP-1, XMP-2 | |

BLOCK DIAGRAM


20445-5

APPLICATION CIRCUIT

ABSOLUTE MAXIMUM RATINGS

| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
|-----------------------------|-----------------------------|-----------|-----------------------|------|
| Supply voltage | | V_S | -0.3 to +6 | V |
| Supply current | | I_S | 3 | mA |
| Output voltage | | V_O | -0.3 to $(V_S + 0.3)$ | V |
| Output current | | I_O | 5 | mA |
| Junction temperature | | T_j | 100 | °C |
| Storage temperature range | | T_{stg} | -25 to +85 | °C |
| Operating temperature range | | T_{amb} | -25 to +85 | °C |
| Power consumption | $T_{amb} \leq 85\text{ °C}$ | P_{tot} | 10 | mW |

Note

- Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability

ELECTRICAL AND OPTICAL CHARACTERISTICS ($T_{amb} = 25\text{ °C}$, unless otherwise specified)

| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|-----------------------|--|---------------------|------|----------|------|-------------------|
| Supply voltage | | V_S | 2.5 | - | 5.5 | V |
| Supply current | $V_S = 3.3\text{ V}$, $E_v = 0$ | I_{SD} | 0.27 | 0.35 | 0.45 | mA |
| | $E_v = 40\text{ klx}$, sunlight | I_{SH} | - | 0.45 | - | mA |
| Transmission distance | $E_v = 0$, IR diode TSAL6200, $I_F = 50\text{ mA}$, test signal see Fig. 1 | d | - | 24 | - | m |
| Output voltage low | $I_{OSL} = 0.5\text{ mA}$, $E_e = 0.7\text{ mW/m}^2$, test signal see Fig. 1 | V_{OSL} | - | - | 100 | mV |
| Minimum irradiance | Pulse width tolerance: $t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o$, test signal see Fig. 1 | $E_{e\text{ min.}}$ | - | 0.12 | 0.25 | mW/m ² |
| Maximum irradiance | $t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o$, test signal see Fig. 1 | $E_{e\text{ max.}}$ | 30 | - | - | W/m ² |
| Directivity | Angle of half transmission distance | $\phi_{1/2}$ | - | ± 75 | - | ° |

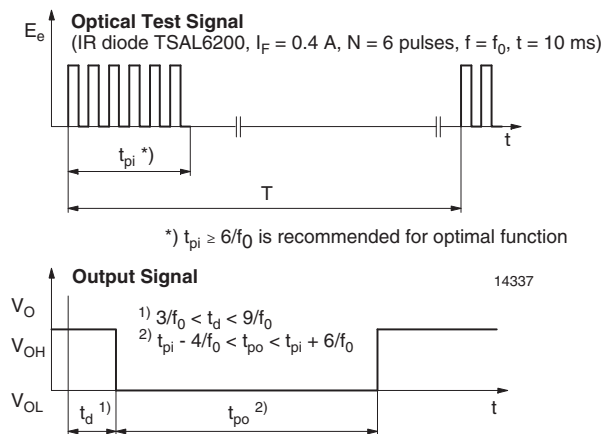
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 1 - Output Function

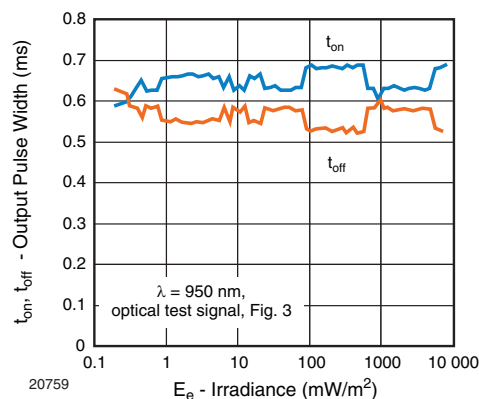


Fig. 4 - Output Pulse Diagram

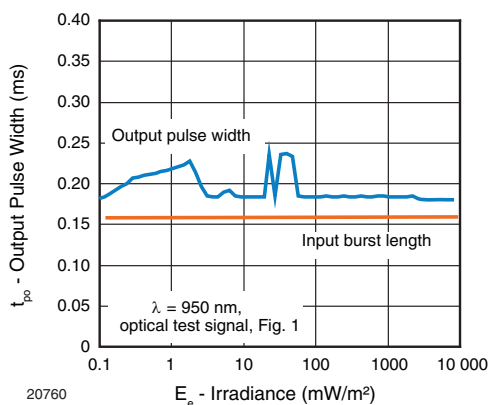


Fig. 2 - Output Pulse Width vs. Irradiance

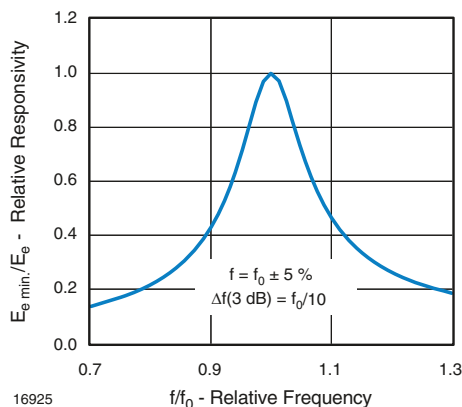


Fig. 5 - Frequency Dependence of Responsivity

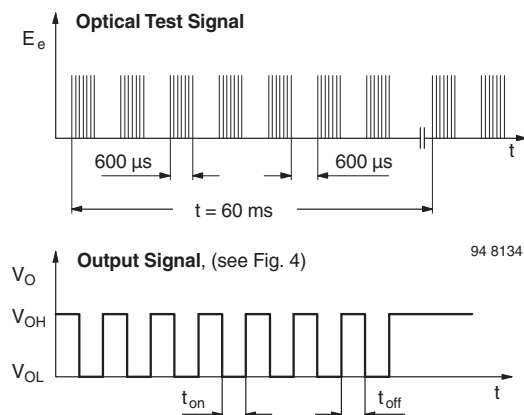


Fig. 3 - Output Function

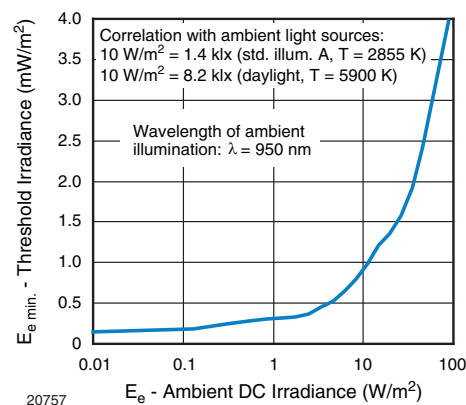


Fig. 6 - Sensitivity in Bright Ambient

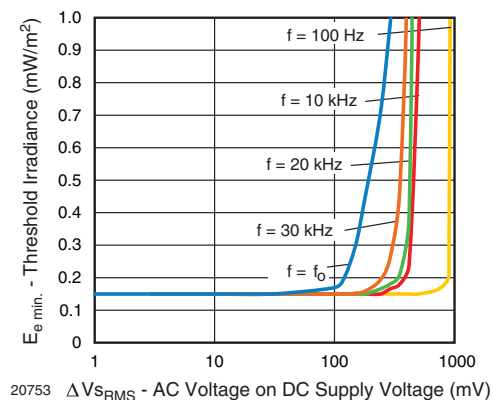


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

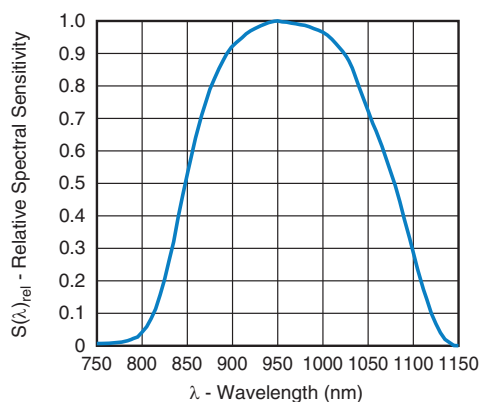


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

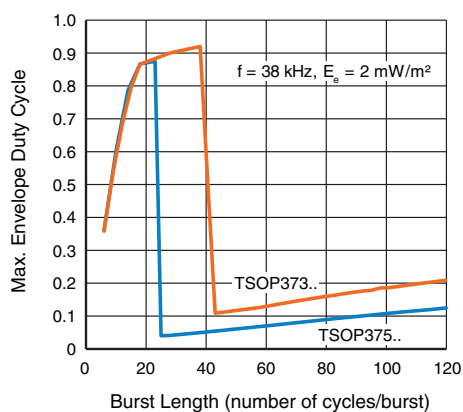


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

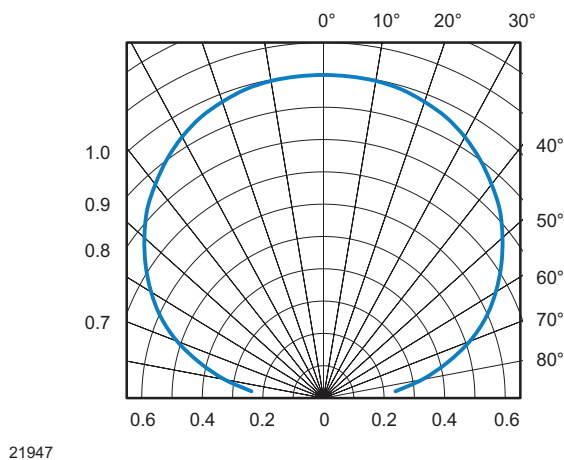


Fig. 11 - Directivity

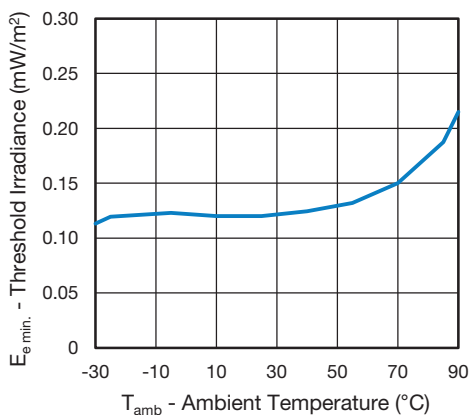


Fig. 9 - Sensitivity vs. Ambient Temperature

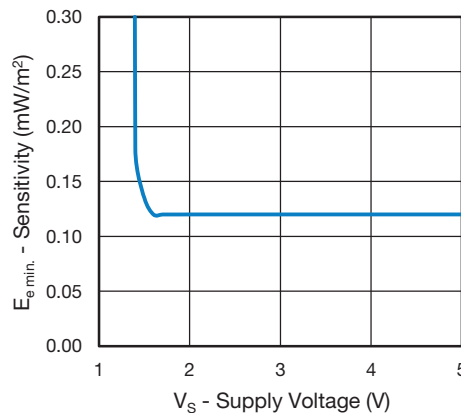


Fig. 12 - Sensitivity vs. Supply Voltage

SUITABLE DATA FORMAT

The TSOP373.., TSOP375.. series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the TSOP373.., TSOP375.. in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output. Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see Fig. 13 or Fig. 14)



Fig. 13 - IR Signal from Fluorescent Lamp With Low Modulation

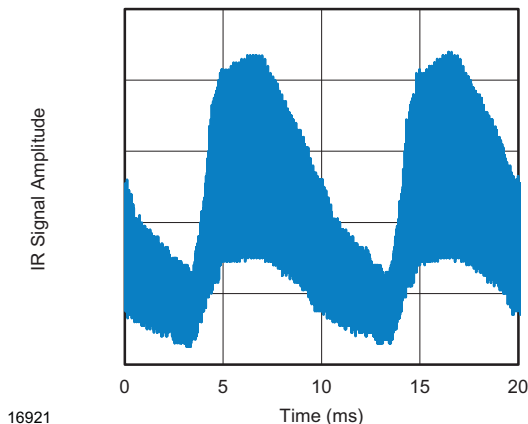


Fig. 14 - IR Signal from Fluorescent Lamp With High Modulation

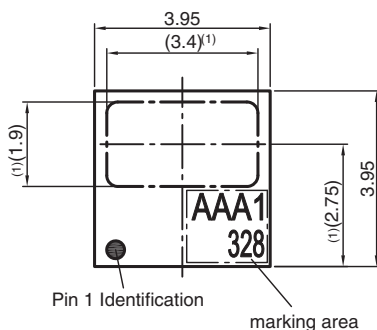
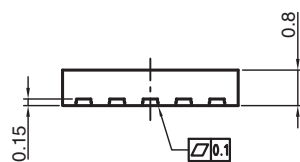
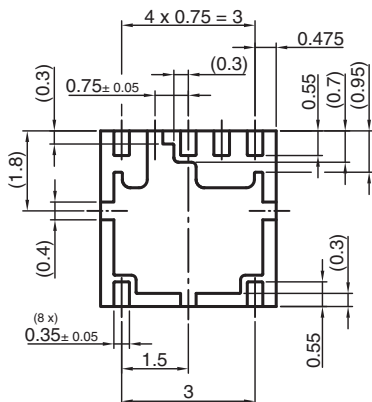
| | TSOP373.. | TSOP375.. |
|---|--|---|
| Minimum burst length | 6 cycles/burst | 6 cycles/burst |
| After each burst of length a minimum gap time is required of | 6 to 35 cycles ≥ 10 cycles | 6 to 24 cycles ≥ 10 cycles |
| For bursts greater than a minimum gap time in the data stream is needed of | 35 cycles > 6 x burst length | 24 cycles > 25 ms |
| Maximum number of continuous short bursts/second | 2000 | 2000 |
| MCIR code | Preferred | Yes |
| RCMM code | Preferred | Yes |
| XMP-1, XMP-2 code | Preferred | Yes |
| Suppression of interference from fluorescent lamps | Mild and complex disturbance patterns are suppressed (example: signal pattern of Fig. 13 and 14) | Critical disturbance patterns are suppressed, e.g. highly dimmed LCDs |

Note

- For data formats with long bursts (more than 10 carrier cycles) please see the datasheet for TSOP372.., TSOP374..



PACKAGE DIMENSIONS in millimeters



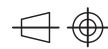
Drawing-No.: 6.550-5315.01-4
Issue: 2; 12.02.14

Notes

(1) Optically effective area

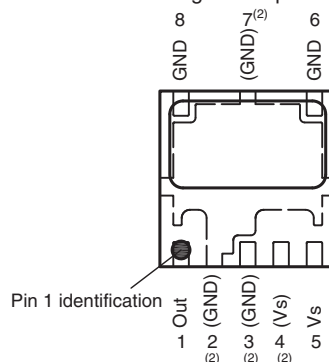
(2) Pins connected internally. It is not necessary to connect externally

Not indicated tolerances ± 0.1

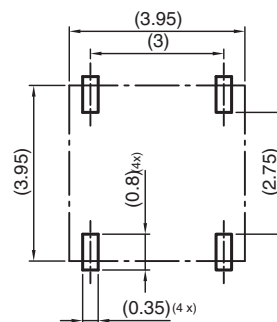


technical drawings
according to DIN
specifications

Pinning from topview



Proposed pad layout from
component side
(dim. for reference only)





ASSEMBLY INSTRUCTIONS

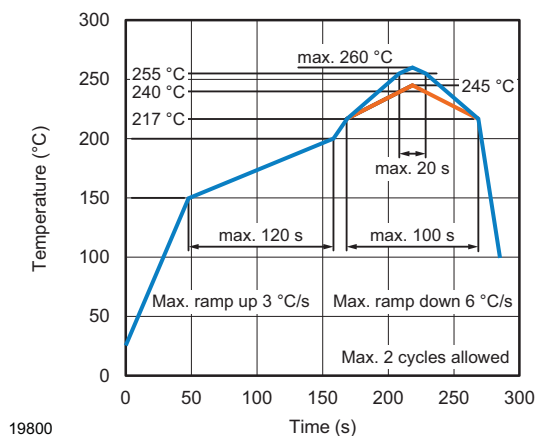
Reflow Soldering

- Reflow soldering must be done within 168 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



| ORDERING INFORMATION | | | |
|----------------------|---------------|-----------------------|-----------------------------|
| ORDERING CODE | PACKAGING | VOLUME ⁽¹⁾ | REMARKS |
| TSOP37..TT1 | Tape and reel | MOQ: 1800 pcs | 3.95 mm x 3.95 mm x 0.75 mm |
| TSOP37..TT2 | | MOQ: 7000 pcs | |

Note

⁽¹⁾ MOQ: minimum order quantity

LABEL

Standard bar code labels for finished goods

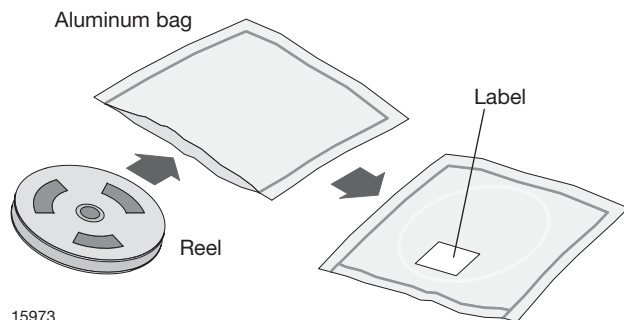
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled

with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

| VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods) | | |
|---|---------------------|---------------|
| PLAIN WRITING | ABBREVIATION | LENGTH |
| Item-description | - | 18 |
| Item-number | INO | 8 |
| Selection-code | SEL | 3 |
| LOT-/serial-number | BATCH | 10 |
| Data-code | COD | 3 (YWW) |
| Plant-code | PTC | 2 |
| Quantity | QTY | 8 |
| Accepted by | ACC | - |
| Packed by | PCK | - |
| Mixed code indicator | MIXED CODE | - |
| Origin | xxxxxxx+ | Company logo |
| Long bar code top | Type | Length |
| Item-number | N | 8 |
| Plant-code | N | 2 |
| Sequence-number | X | 3 |
| Quantity | N | 8 |
| Total length | - | 21 |
| Short bar code bottom | Type | Length |
| Selection-code | X | 3 |
| Data-code | N | 3 |
| Batch-number | X | 10 |
| Filter | - | 1 |
| Total length | - | 17 |

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:
192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen)
or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers
or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 3 label is included on all dry bags.



| | | |
|---|--|--|
|  | Caution | LEVEL |
| | This bag contains MOISTURE-SENSITIVE DEVICES | 3 <small>If blank, see adjacent bar code label</small> |
| 1. Calculated shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH) | | |
| 2. Peak package body temperature: <u>260</u> °C <small>If blank, see adjacent bar code label</small> | | |
| 3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be | | |
| a) Mounted within: <u>168</u> hours of factory conditions <small>If blank, see adjacent bar code label</small> | | |
| b) Stored per J-STD-033 | | |
| 4. Devices require bake, before mounting, if: | | |
| a) Humidity Indicator Card reads > 10% for level 2a - 5a devices or >60% for level 2 devices when read at 23±5°C | | |
| b) 3a or 3b are not met | | |
| 5. If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure | | |
| Bag Seal Date: _____ <small>If blank, see adjacent bar code label</small> | | |
| <small>Note: Level and body temperature defined by IPC/JEDEC J-STD-020</small> | | |

22650

EIA JEDC standard J-STD-020 level 3 label is included on all dry bags

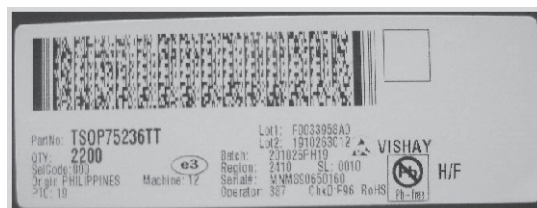
ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

BAR CODE PRODUCT LABEL (example)



22178



Tape and Reel Standards for Surface-Mount IR Receiver Modules

Vishay Semiconductor surface-mount IR receivers are packaged on tape and reel. The following specification is based on IEC publication 286, which takes the industrial requirements for automatic insertion into account.

Absolute maximum ratings, mechanical dimensions, optical and electrical characteristics for taped devices are identical to the basic catalog types and can be found in the specifications for untaped devices.

PACKAGING

The tapes of components are available on reels. Each reel is marked with labels which contain the following information:

- Vishay
- Type
- Group
- Tape code, normally part of type name
- Production code
- Quantity

MISSING COMPONENTS

Up to 3 consecutive components may be missing if the gap is followed by at least 6 components. A maximum of 0.5 % of the components per reel quantity may be missing. At least 5 empty positions are present at the start and the end of the tape to enable tape insertion.

Tensile strength of the tape: > 15 N

NUMBER OF COMPONENTS

- A. Panhead: quantity per reel:
 - TT, top view package, 1190 pcs
 - TR, side view package, 1120 pcs
- B. Heimdall: quantity per reel:
 - TT, top view package, 2200 pcs
 - TR, side view package, 2300 pcs
- C. Heimdall without lens: quantity per reel:
 - WTT, top view package, 2200 pcs
 - WTR, side view package, 2300 pcs
- D. Belobog: quantity per reel:
 - TT1, top view package, 1800 pcs
- E. Belobog with shield: quantity per reel:
 - TT1, top view package, 1500 pcs
- F. Minimold DF1P: quantity per reel:
 - DF1P, 1100 pcs
- G. TVCastSMD TR1: quantity per reel:
 - TR1, side view package, 2000 pcs

ORDER DESIGNATION

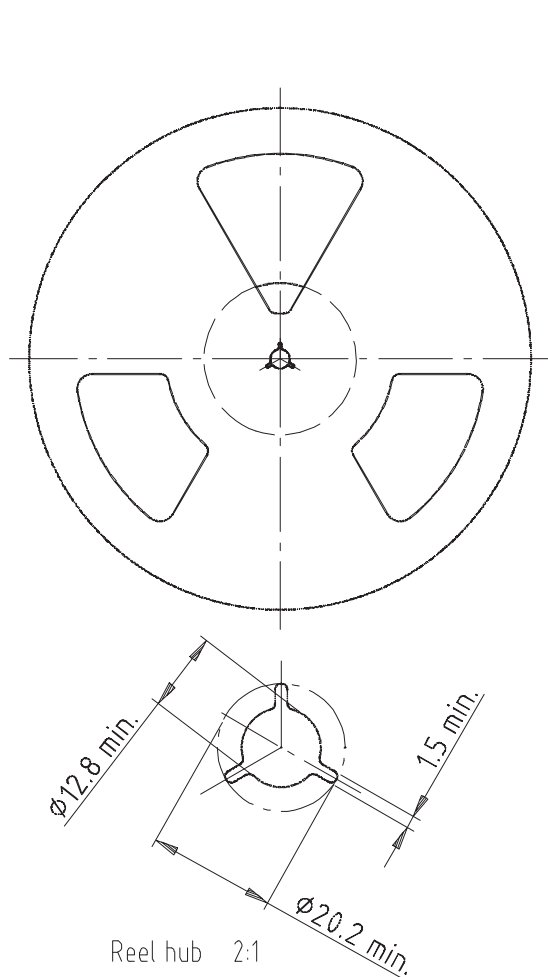
The type designation of the device is extended by TT or TT1 for top view or TR for side view.

Example:

TSOP6238TR (reel packing)
TSOP75238TR (reel packing)
TSOP75338WTT (reel packing)
TSOP57438TT1 (reel packing)
TSOP57238HTT1 (reel packing)
TSOP39438TR1 (reel packing)



REEL DIMENSIONS FOR PANHEAD, HEIMDALL, AND TVCASTSMD TR in millimeters



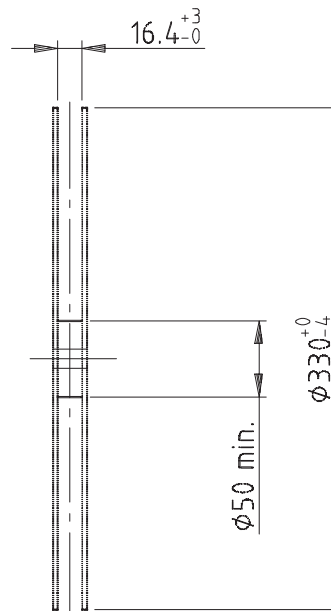
Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734

Note

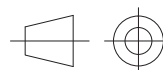
- The body structure of the reel can vary



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

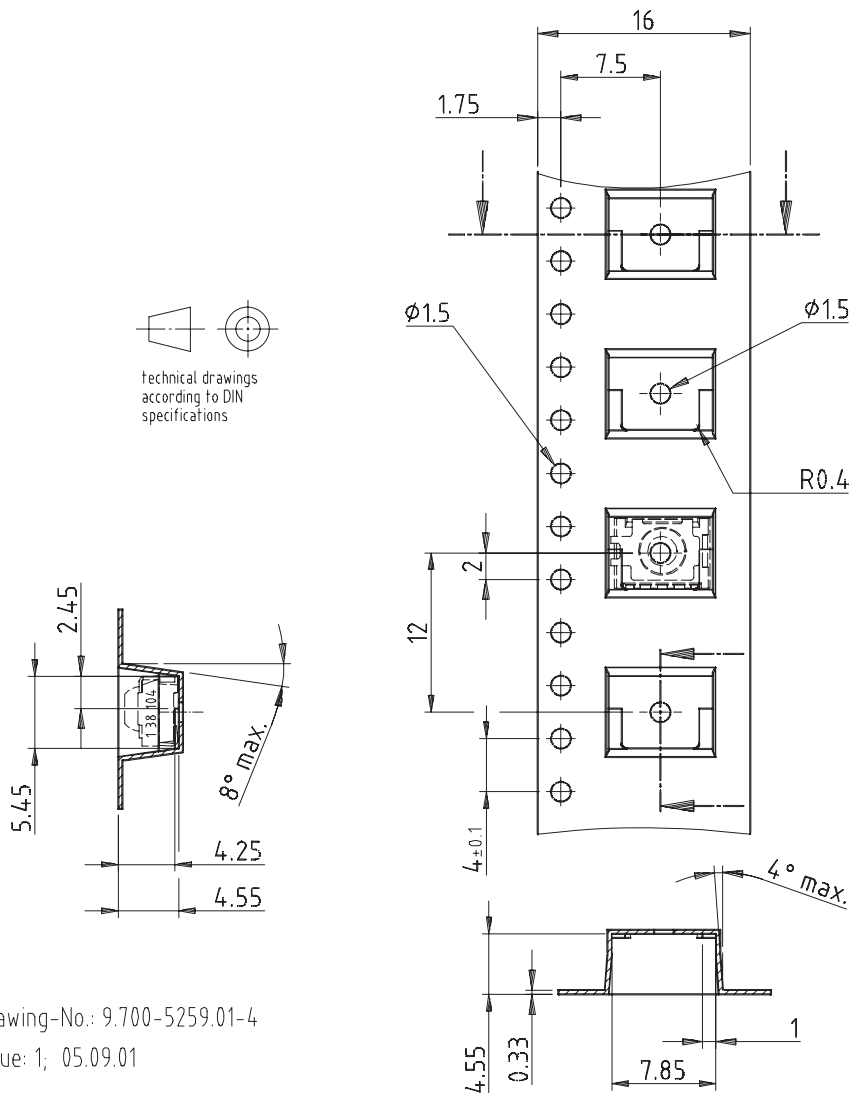
Tape width 16



technical drawings
according to DIN
specifications

TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

A. Panhead (TSOP36...TT, TSSP....TT, TSOP6...TT, TSOP16...TT, TSOP96...TT)



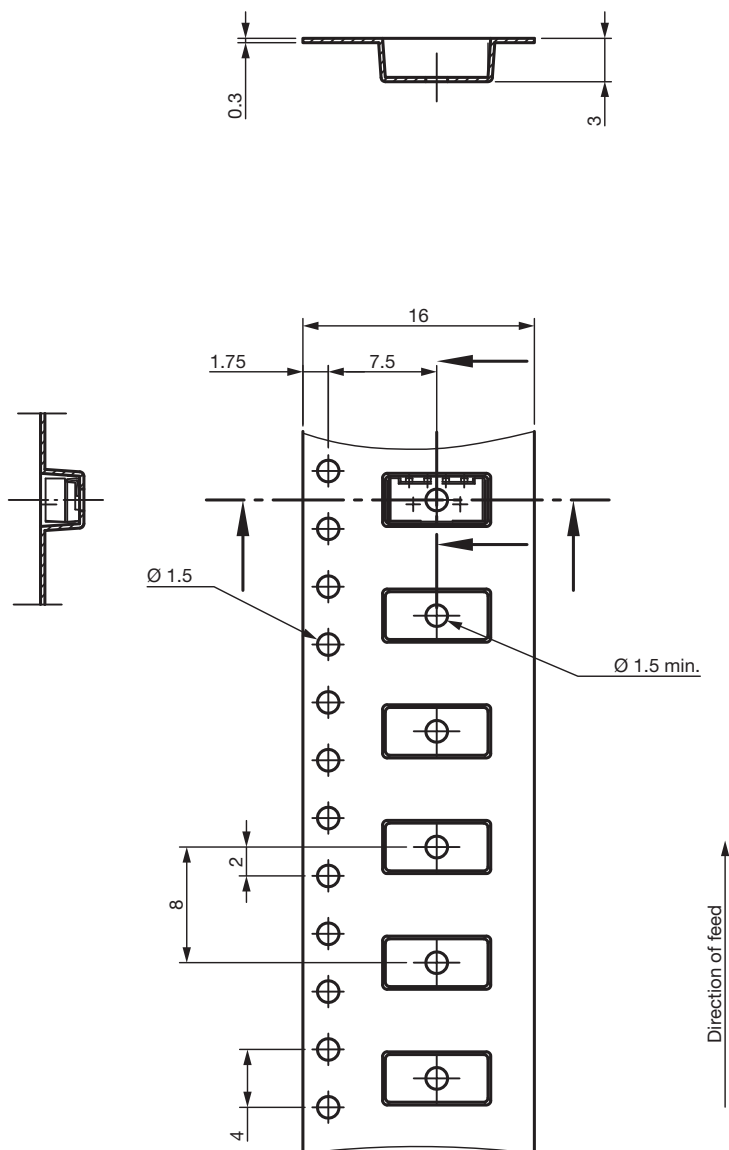
Drawing-No.: 9.700-5259.01-4

Issue: 1; 05.09.01

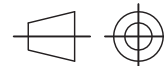
16584

TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

C. Heimdall without lens (TSOP75...WTT, TSOP77...WTT, TSSP77...WTT, TSOP15...WTT, TSOP95...WTT)



Drawing-No.: 9.700-5341.01-4
Issue: 3; 06.10.15

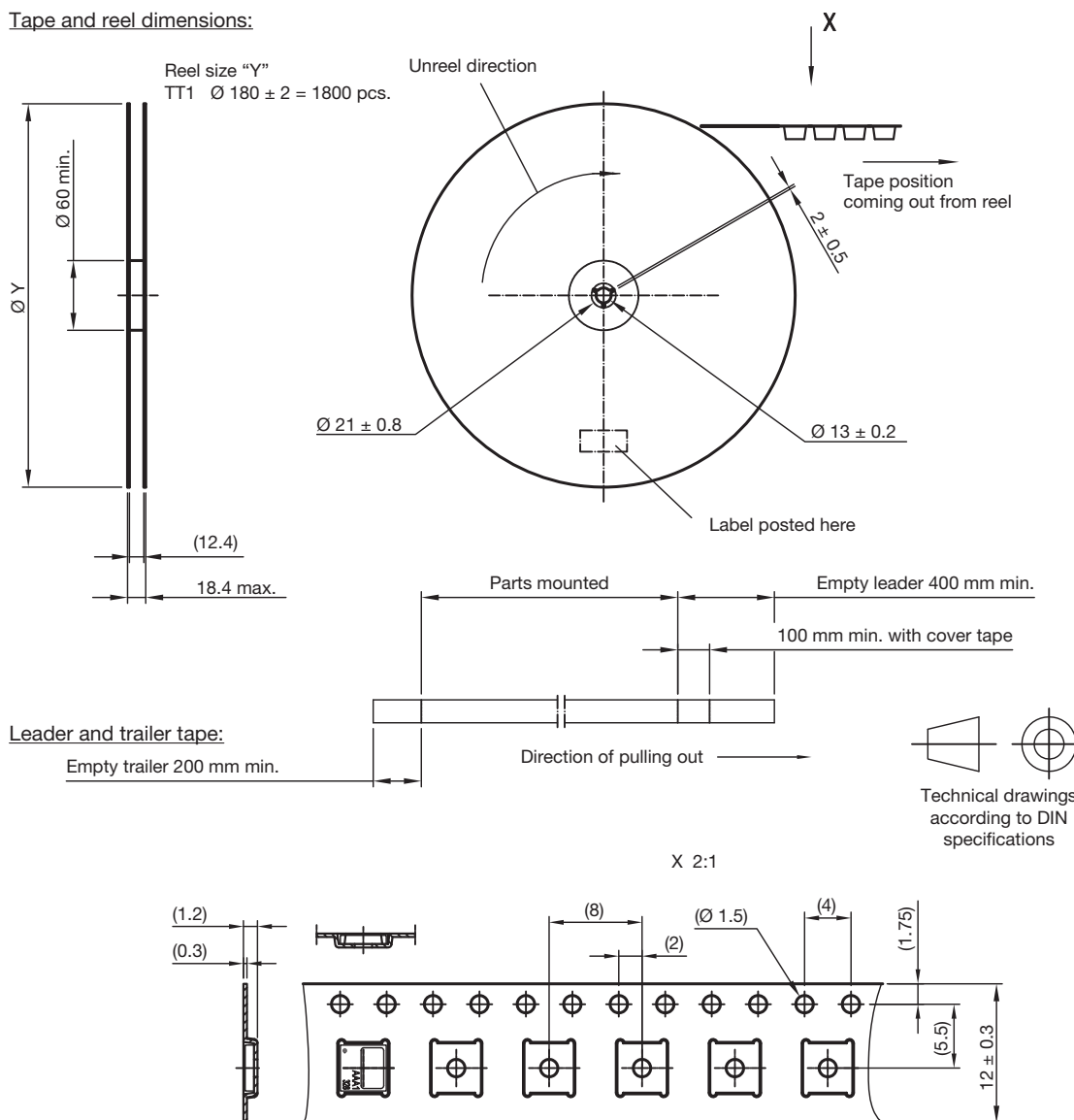


technical drawings
according to DIN
specifications

TAPING VERSION TSOP..TT1 (TOP VIEW) DIMENSIONS in millimeters

D. Belobog (TSOP37...TT1, TSOP57...TT1, TSOP17...TT1, TSOP97...TT1)

Tape and reel dimensions:



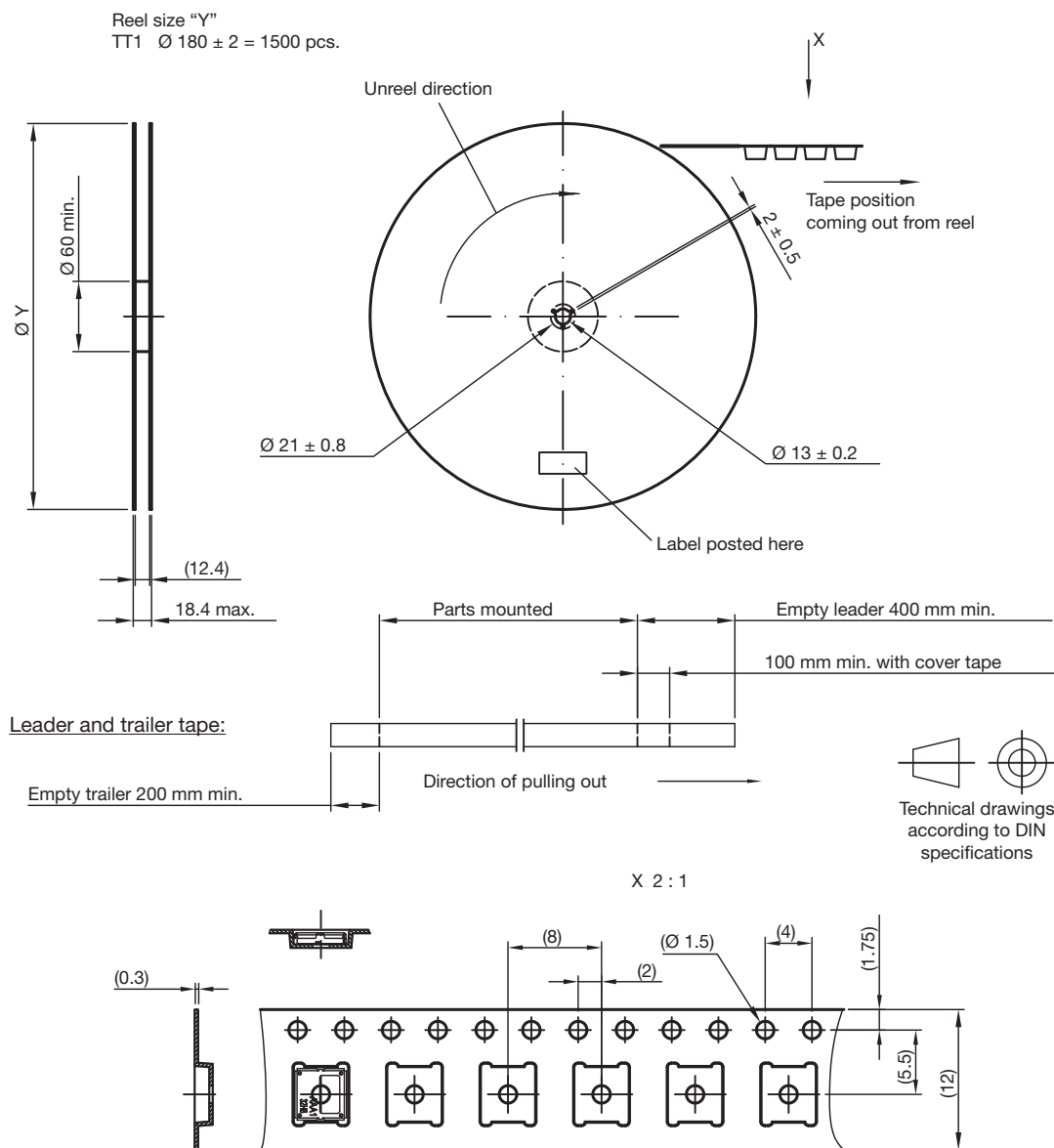
Drawing-No.: 9.700-5347.01-4
Issue: 2; 07.03.18

Not indicated tolerances ± 0.1

TAPING VERSION TSOP..TT1 (TOP VIEW) DIMENSIONS in millimeters

E. Belobog with shield (TSOP37...HTT1, TSOP57...HTT1, TSOP17...HTT1, TSOP97...HTT1)

Tape and reel dimensions:

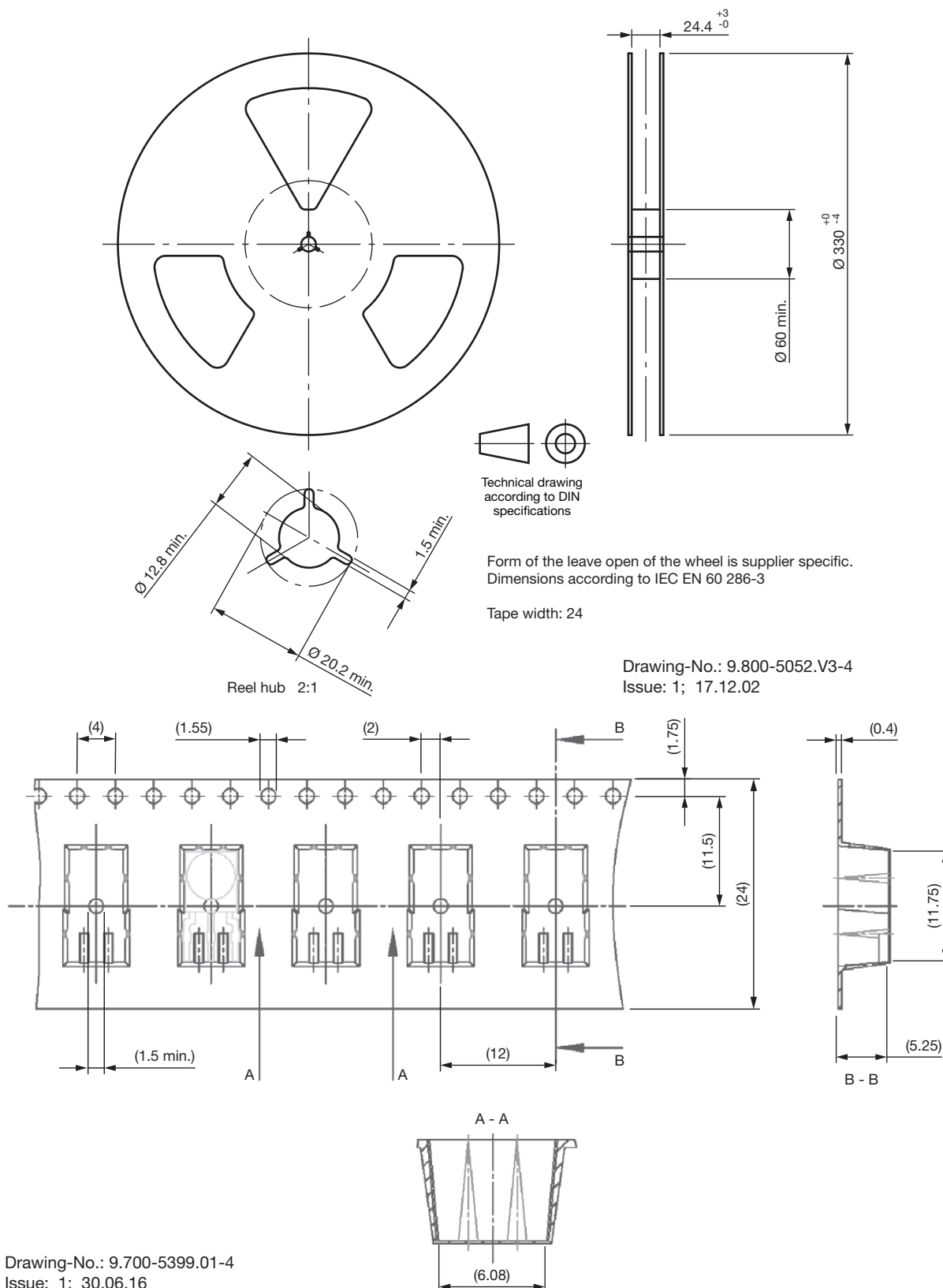


Drawing-No.: 9.700-5380.01-4
Issue: 3; 07.03.18

Not indicated tolerances ± 0.1

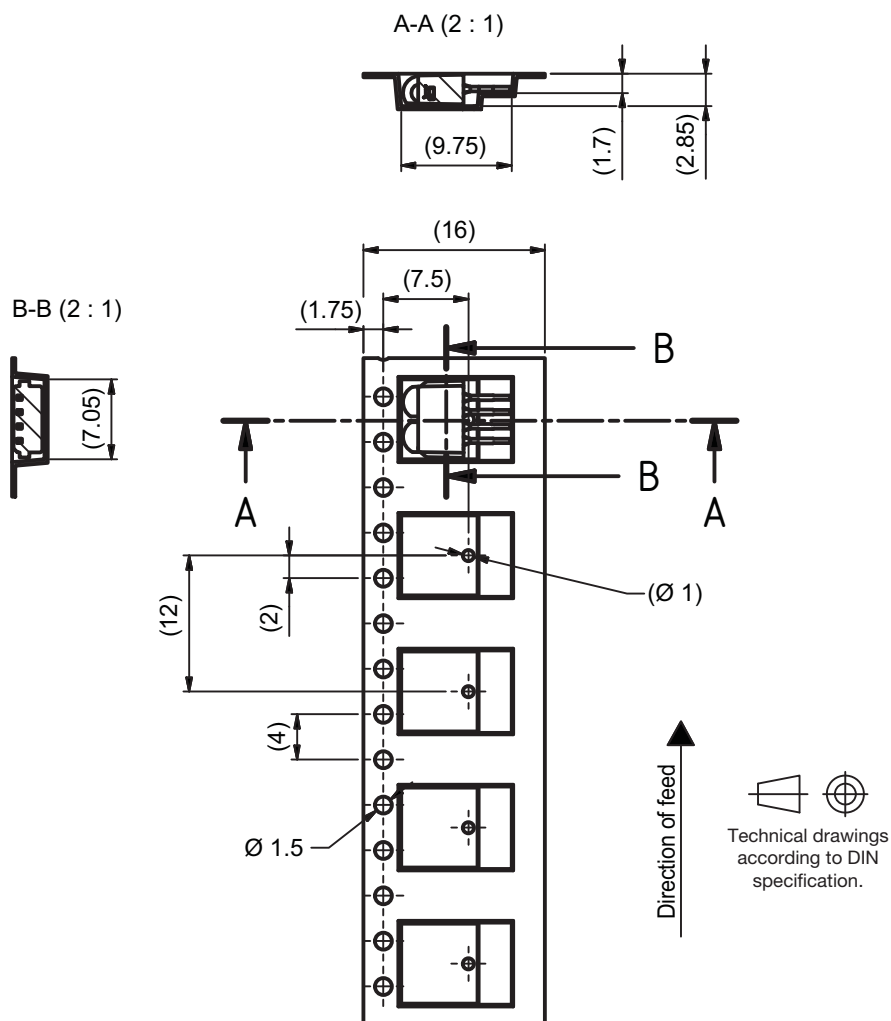
TAPING VERSION TSOP..DF1P (SIDE VIEW) DIMENSIONS in millimeters

F. Minimold DF1P (TSOP33...DF1P, TSOP53...DF1P, TSOP13...DF1P, TSOP93...DF1P)



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

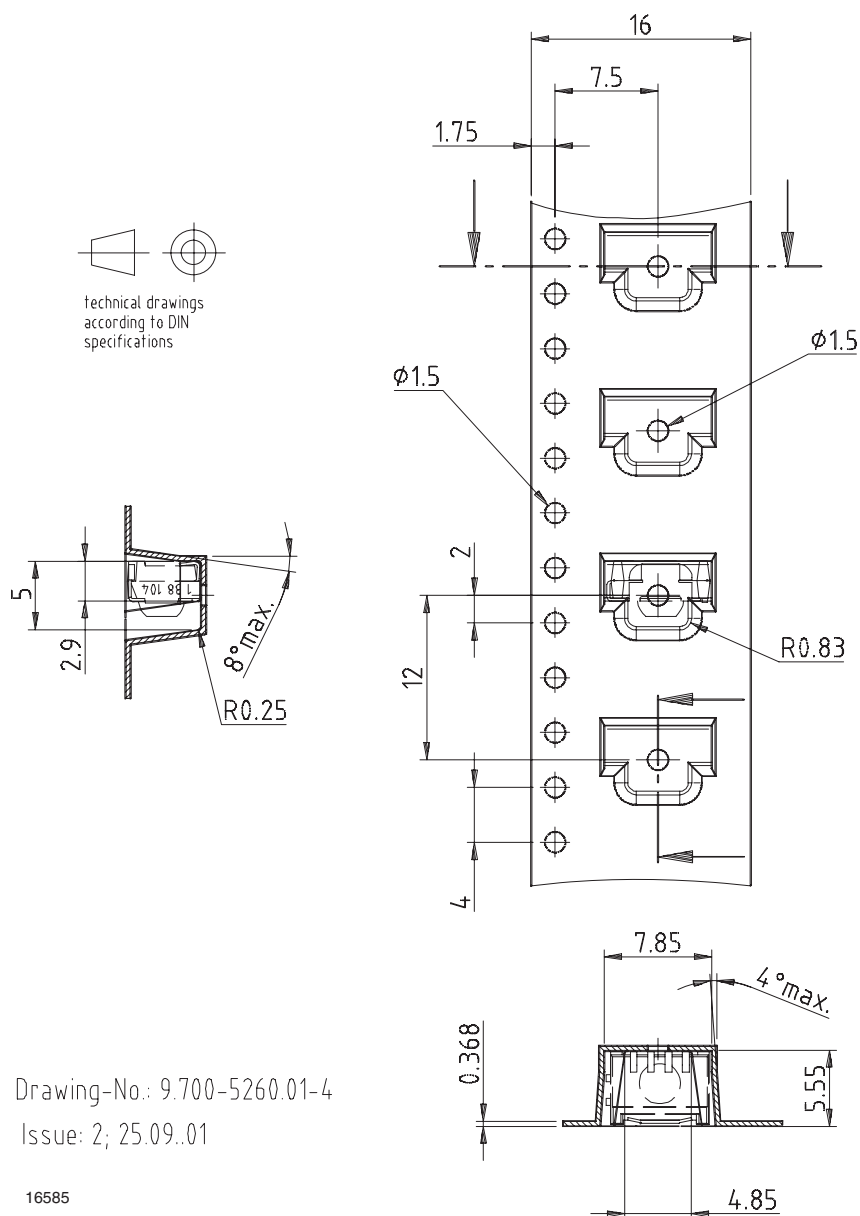
G. TVCastSMD TR1 (TSOP59...TR1, TSOP39...TR1, TSOP19...TR1, TSOP99...TR1)



Drawing-No.: GO-100220.10_Z
Issue B: 08.02.17

TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

A. Panhead (TSOP36...TR, TSSP6...TR, TSOP6...TR, TSOP16...TR, TSOP96...TR)



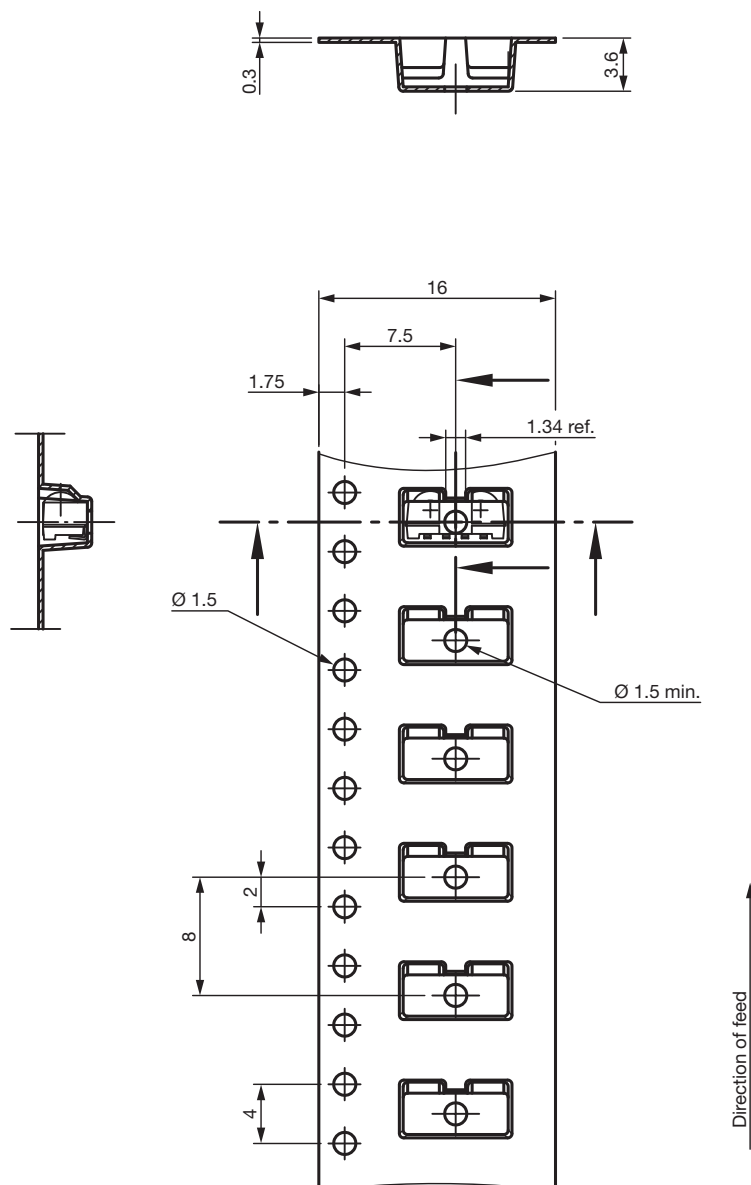
Drawing-No.: 9.700-5260.01-4

Issue: 2; 25.09..01

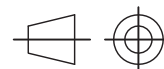
16585

TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

B. Heimdall (TSSP7...., TSOP75...TR, TSOP77...TR, TSSP7....TR, TSOP15...TR, TSOP95...TR)



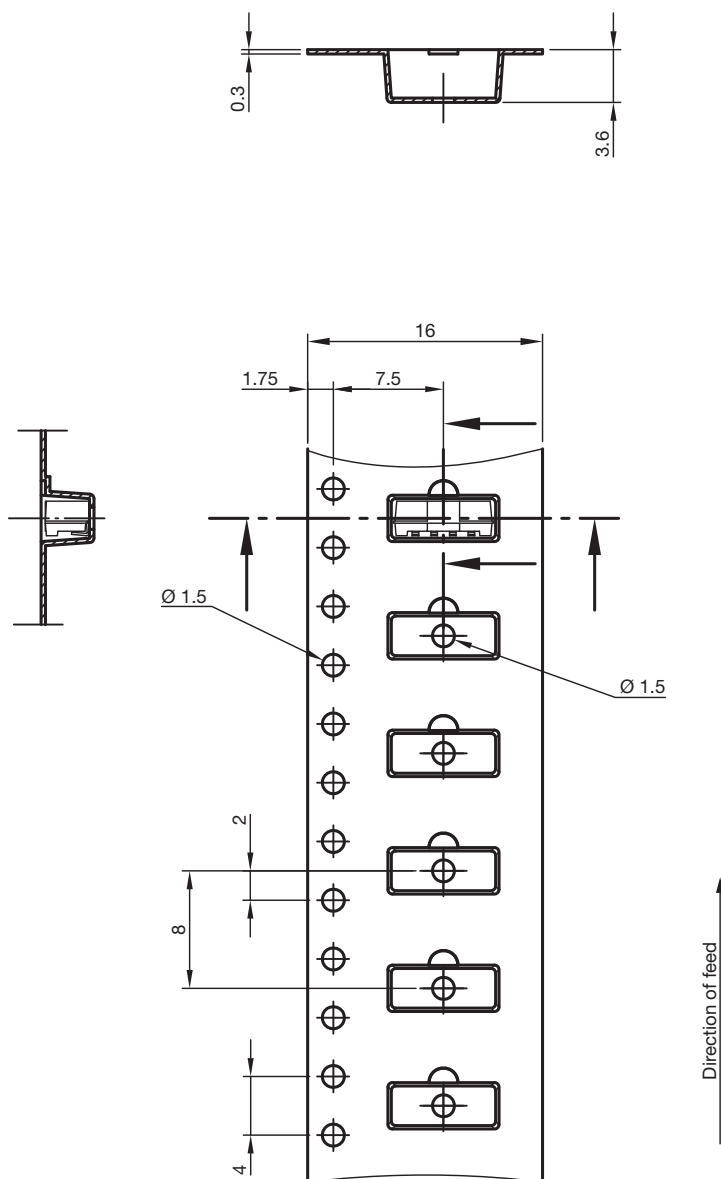
Drawing-No.: 9.700-5337.01-4
Issue: 2; 06.10.15



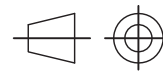
technical drawings
according to DIN
specifications

TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

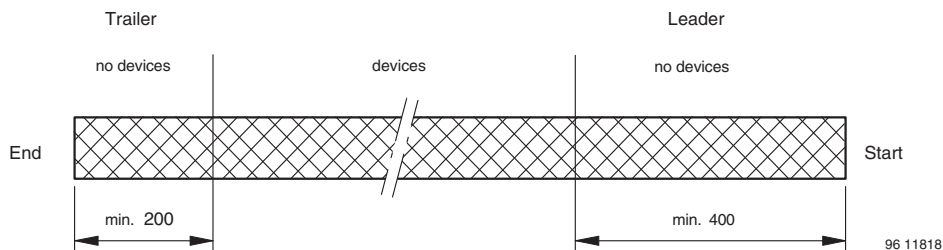
C. Heimdall without lens (TSOP75...WTR, TSOP77...WTR, TSSP...WTR, TSOP15...WTR, TSOP95...WTR)



Drawing-No.: 9.700-5342.01-4
Issue: 2; 12.06.13


technical drawings
according to DIN
specifications

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE REEL STRENGTH

According to DIN EN 60286-3

0.1 N to 1.3 N

300 mm/min. \pm 10 mm/min.

165° to 180° peel angle

LABEL

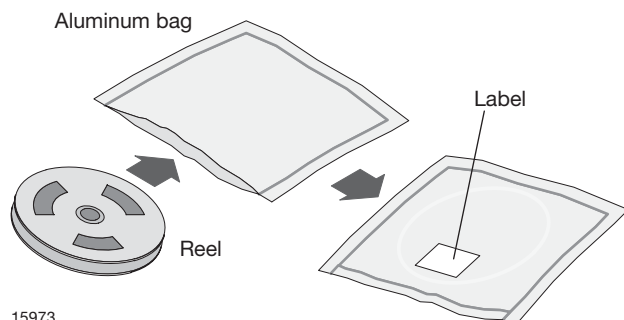
Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

| VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods) | | |
|--|--------------|--------------|
| PLAIN WRITING | ABBREVIATION | LENGTH |
| Item-description | - | 18 |
| Item-number | INO | 8 |
| Selection-code | SEL | 3 |
| LOT-/serial-number | BATCH | 10 |
| Data-code | COD | 3 (YWW) |
| Plant-code | PTC | 2 |
| Quantity | QTY | 8 |
| Accepted by | ACC | - |
| Packed by | PCK | - |
| Mixed code indicator | MIXED CODE | - |
| Origin | xxxxxxx+ | Company logo |
| LONG BAR CODE TOP | TYPE | LENGTH |
| Item-number | N | 8 |
| Plant-code | N | 2 |
| Sequence-number | X | 3 |
| Quantity | N | 8 |
| Total length | - | 21 |
| SHORT BAR CODE TOP | TYPE | LENGTH |
| Selection-code | X | 3 |
| Data-code | N | 3 |
| Batch-number | X | 10 |
| Filter | - | 1 |
| Total length | - | 17 |

DRY PACKAGING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



15973

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.


In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JSTD-020 level 4 label is included on all dry bags.



CAUTION
This bag contains
MOISTURE-SENSITIVE DEVICES

LEVEL
4

1. Shelf life in sealed bag: 12 months at < 40 °C and < 90 % relative humidity (RH)
2. After this bag is opened, devices that will be subjected to soldering reflow or equivalent processing (peak package body temp. 260 °C) must be
 - 2a. Mounted within 72 hours at factory condition of < 30 °C/60 % RH or
 - 2b. Stored at < 5 % RH
3. Devices require baking before mounting if:
Humidity Indicator Card is > 10 % when read at 23 °C ± 5 °C or 2a. or 2b. are not met.
4. If baking is required, devices may be baked for:
 - 192 hours at 40 °C + 5 °C/- 0 °C and < 5 % RH (dry air/nitrogen) or
 - 96 hours at 60 °C ± 5 °C and < 5 % RH for all device containers or
 - 24 hours at 125 °C ± 5 °C not suitable for reels or tubes

Bag Seal Date: _____
(If blank, see barcode label)

Note: Level and body temperature defined by EIA JEDEC Standard J-STD-020

22522

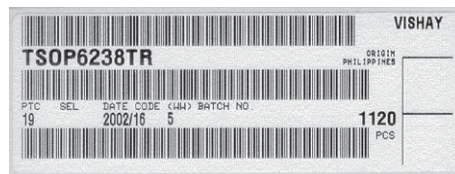
EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

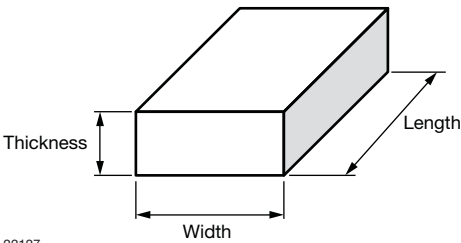
The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



16962

OUTER PACKAGING

The sealed reel is packed into a pizza box.

| CARTON BOX DIMENSIONS in millimeters | | | |
|--|------------------|--------------|---------------|
|  | | | |
| | THICKNESS | WIDTH | LENGTH |
| Pizza box (SMD and heimdall) (taping in reels) | 50 | 340 | 340 |



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